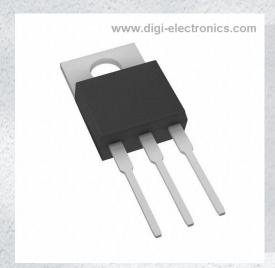


IRFBE20PBF Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number

IRFBE20PBF-DG

Manufacturer

Vishay Siliconix

Manufacturer Product Number

IRFBE20PBF

Description

MOSFET N-CH 800V 1.8A TO220AB

Detailed Description

N-Channel 800 V 1.8A (Tc) 54W (Tc) Through Hole T

O-220AB



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
IRFBE20PBF	Vishay Siliconix
Series:	Packaging:
	Tube
Part Status:	FET Type:
Active	N-Channel
Technology:	Drain to Source Voltage (Vdss):
MOSFET (Metal Oxide)	800 V
Current - Continuous Drain (Id) @ 25°C:	Drive Voltage (Max Rds On, Min Rds On):
1.8A (Tc)	10V
Rds On (Max) @ Id, Vgs:	Vgs(th) (Max) @ Id:
6.50hm @ 1.1A, 10V	4V @ 250μA
Gate Charge (Qg) (Max) @ Vgs:	Vgs (Max):
38 nC @ 10 V	±20V
Input Capacitance (Ciss) (Max) @ Vds:	FET Feature:
530 pF @ 25 V	
Power Dissipation (Max):	Operating Temperature:
54W (Tc)	-55°C ~ 150°C (TJ)
Mounting Type:	Supplier Device Package:
Through Hole	TO-220AB
Package / Case:	Base Product Number:
TO-220-3	IRFBE20

Environmental & Export classification

8541.29.0095

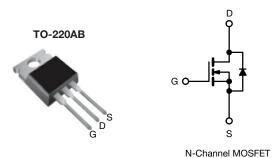
RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Affected	EAR99
HTSUS:	





Vishay Siliconix

Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V)	800			
$R_{DS(on)}(\Omega)$	V _{GS} = 10 V	6.5		
Q _g max. (nC)	38			
Q _{gs} (nC)	5.0			
Q _{gd} (nC)	21			
Configuration	Single			

FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- · Fast switching
- · Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFBE20PbF
Lead (Pb)-free and halogen-free	IRFBE20PbF-BE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	800	V	
Gate-source voltage			V_{GS}	± 20	V	
Continuous drain current	V _{GS} at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$		1.8	А	
		T _C = 100 °C	I _D	1.2		
Pulsed drain current ^a			I _{DM}	7.2		
Linear derating factor				0.43	W/°C	
Single pulse avalanche energy b			E _{AS}	180	mJ	
Repetitive avalanche current a			I _{AR}	1.8	Α	
Repetitive avalanche energy ^a			E _{AR}	5.4	mJ	
Maximum power dissipation	T _C = 25 °C		P _D	54	W	
Peak diode recovery dV/dt ^c			dV/dt	2.0	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) ^d	For 10 s			300		
Mauring town	6-32 or M3 screw			10	lbf ⋅ in	
Mounting torque				1.1	N⋅m	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 104 mH, R_g = 25 Ω , I_{AS} = 1.8 A (see fig. 12)
- c. $I_{SD} \le 1.8$ A, $dI/dt \le 80$ A/ μ s, $V_{DD} \le 600$, $T_{J} \le 150$ °C
- d. 1.6 mm from case



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	62	
Case-to-sink, flat, greased surface	R _{thCS}	0.50	-	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	2.3	

PARAMETER	SYMBOL	TEST	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0$	V, I _D = 250 μA	800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = 1 mA	-	0.98	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V$	_{GS} , I _D = 250 μA	2.0	-	4.0	٧
Gate-source leakage	I _{GSS}		V _{GS} = ± 20 V		-	± 100	nA
7		$V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	100	μΑ
Zero gate voltage drain current	I _{DSS}	V _{DS} = 640 V, \	V _{DS} = 640 V, V _{GS} = 0 V, T _J = 125 °C		-	500	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V		-	-	6.5	Ω
Forward transconductance	9 _{fs}	V _{DS} = 10	00 V, I _D = 1.1 A b	0.80	-	-	S
Dynamic		•			•	•	
Input capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz, see fig. 5}$		-	530	-	pF
Output capacitance	C _{oss}			-	150	-	
Reverse transfer capacitance	C _{rss}			-	90	-	
Total gate charge	Q _g		I _D = 1.8 A, V _{DS} = 400 V, see fig. 6 and 13 ^b	-	-	38	nC
Gate-source charge	Q_{gs}	V _{GS} = 10 V		-	-	5.0	
Gate-drain charge	Q _{gd}			-	-	21	
Turn-on delay time	t _{d(on)}	$V_{DD} = 400 \text{ V, } I_D = 1.8 \text{ A,}$ $R_g = 18 \Omega, R_D = 230 \Omega, \text{ see fig. } 10^{\text{ b}}$		-	8.2	-	- ns
Rise time	t _r			-	17	-	
Turn-off delay time	t _{d(off)}			-	58	-	
Fall time	t _f			-	27	-	
Gate input resistance	R_g	f = 1 M	f = 1 MHz, open drain		-	4.2	Ω
Internal drain inductance	L _D	6 mm (0.25") f	Between lead, 6 mm (0.25") from		4.5	-	ml I
Internal source inductance	L _S	package and center of die contact		-	7.5	-	- nH
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	I _S	showing the	MOSFET symbol showing the		-	1.8	Α
Pulsed diode forward current ^a	I _{SM}	integral reverse p - n junction diode		-	-	7.2	
Body diode voltage	V _{SD}	$T_J = 25 ^{\circ}\text{C}, I_S = 1.8 \text{A}, V_{GS} = 0 \text{V}^{ \text{b}}$		-	-	1.4	V
Body diode reverse recovery time	t _{rr}	T _J = 25 °C, I _F = 1.8 A, dl/dt = 100 A/µs b		-	380	570	ns
Body diode reverse recovery charge	Q _{rr}			-	0.94	1.4	μC
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_Γ				L _D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

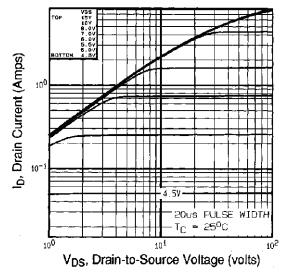


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

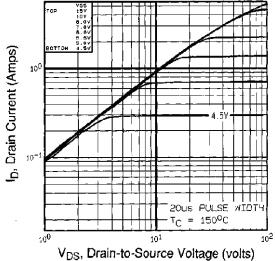


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

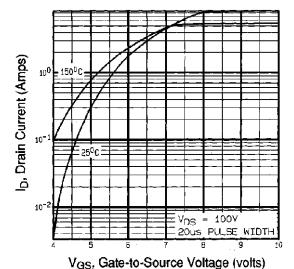


Fig. 3 - Typical Transfer Characteristics

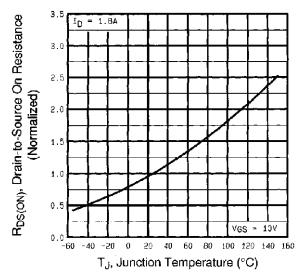


Fig. 4 - Normalized On-Resistance vs. Temperature



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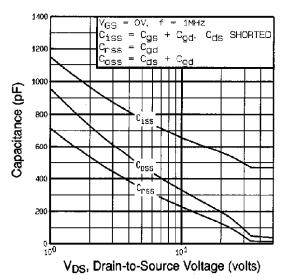


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

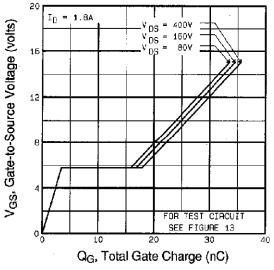


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

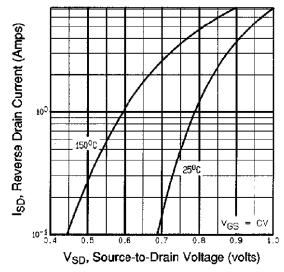


Fig. 7 - Typical Source-Drain Diode Forward Voltage

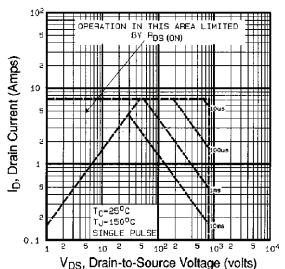


Fig. 8 - Maximum Safe Operating Area



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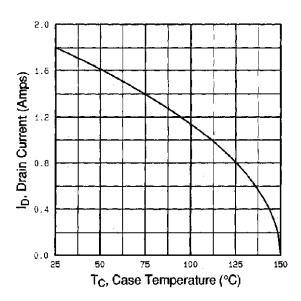


Fig. 9 - Maximum Drain Current vs. Case Temperature

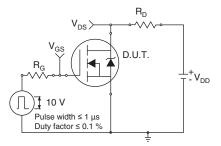


Fig. 10a - Switching Time Test Circuit

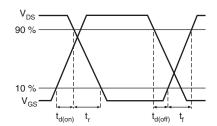


Fig. 10b - Switching Time Waveforms

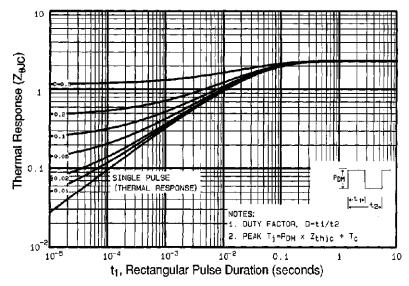


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

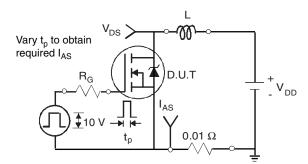


Fig. 12a - Unclamped Inductive Test Circuit

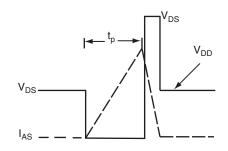


Fig. 12b - Unclamped Inductive Waveforms



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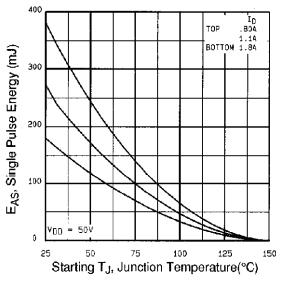


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

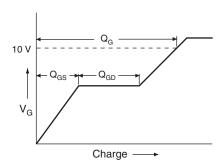


Fig. 13a - Basic Gate Charge Waveform

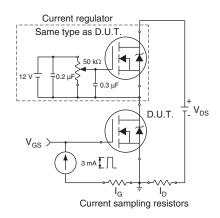
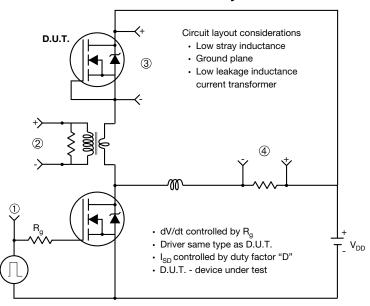


Fig. 13b - Gate Charge Test Circuit



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Peak Diode Recovery dV/dt Test Circuit



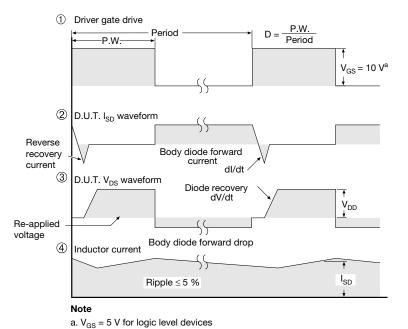


Fig. 14 - For N-Channel

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